

## Description

The HSBA3103 is the high cell density trench P-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

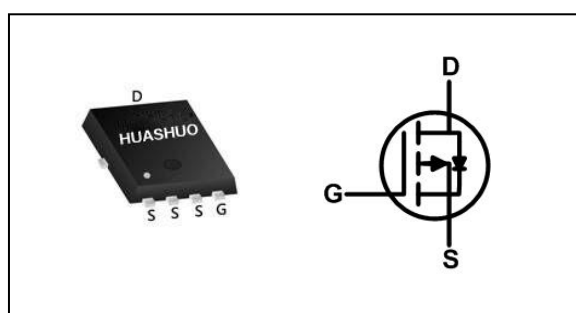
The HSBA3103 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

- 100% EAS Guaranteed
- Green Device Available
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

## Product Summary

|                  |     |    |
|------------------|-----|----|
| $V_{DS}$         | -30 | V  |
| $R_{DS(ON),typ}$ | 14  | mΩ |
| $I_D$            | -35 | A  |

## PRPAK5X6 Pin Configuration



## Absolute Maximum Ratings

| Symbol                 | Parameter                                   | Rating     |              | Units       |
|------------------------|---------------------------------------------|------------|--------------|-------------|
|                        |                                             | 10s        | Steady State |             |
| $V_{DS}$               | Drain-Source Voltage                        | -30        |              | V           |
| $V_{GS}$               | Gate-Source Voltage                         | $\pm 20$   |              | V           |
| $I_D@T_C=25^{\circ}C$  | Continuous Drain Current, $V_{GS} @ -10V^1$ | -35        |              | A           |
| $I_D@T_C=100^{\circ}C$ | Continuous Drain Current, $V_{GS} @ -10V^1$ | -22        |              | A           |
| $I_D@T_A=25^{\circ}C$  | Continuous Drain Current, $V_{GS} @ -10V^1$ | -13.4      | -8.5         | A           |
| $I_D@T_A=70^{\circ}C$  | Continuous Drain Current, $V_{GS} @ -10V^1$ | -10.7      | -6.8         | A           |
| $I_{DM}$               | Pulsed Drain Current <sup>2</sup>           | -95        |              | A           |
| EAS                    | Single Pulse Avalanche Energy <sup>3</sup>  | 72.2       |              | mJ          |
| $I_{AS}$               | Avalanche Current                           | -18        |              | A           |
| $P_D@T_C=25^{\circ}C$  | Total Power Dissipation <sup>4</sup>        | 34.7       |              | W           |
| $P_D@T_A=25^{\circ}C$  | Total Power Dissipation <sup>4</sup>        | 5          | 2            | W           |
| $T_{STG}$              | Storage Temperature Range                   | -55 to 150 |              | $^{\circ}C$ |
| $T_J$                  | Operating Junction Temperature Range        | -55 to 150 |              | $^{\circ}C$ |

## Thermal Data

| Symbol          | Parameter                                                  | Typ. | Max. | Unit          |
|-----------------|------------------------------------------------------------|------|------|---------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup>           | ---  | 62   | $^{\circ}C/W$ |
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup> (t ≤ 10s) | ---  | 25   | $^{\circ}C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>              | ---  | 3.6  | $^{\circ}C/W$ |

**Electrical Characteristics ( $T_J=25\text{ }^{\circ}\text{C}$ , unless otherwise noted)**

| Symbol       | Parameter                                      | Conditions                                          | Min. | Typ. | Max.      | Unit      |
|--------------|------------------------------------------------|-----------------------------------------------------|------|------|-----------|-----------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=-250\mu A$                          | -30  | ---  | ---       | V         |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=-10V, I_D=-15A$                             | ---  | 14   | 17        | $m\Omega$ |
|              |                                                | $V_{GS}=-4.5V, I_D=-10A$                            | ---  | 19   | 24        |           |
| $V_{GS(th)}$ | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=-250\mu A$                      | -1.0 | -1.6 | -2.5      | V         |
| $I_{DSS}$    | Drain-Source Leakage Current                   | $V_{DS}=-24V, V_{GS}=0V, T_J=25^{\circ}\text{C}$    | ---  | ---  | -1        | $\mu A$   |
|              |                                                | $V_{DS}=-24V, V_{GS}=0V, T_J=55^{\circ}\text{C}$    | ---  | ---  | -5        |           |
| $I_{GSS}$    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$                         | ---  | ---  | $\pm 100$ | nA        |
| $g_{fs}$     | Forward Transconductance                       | $V_{DS}=-5V, I_D=-10A$                              | ---  | 5    | ---       | S         |
| $R_g$        | Gate Resistance                                | $V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$               | ---  | 13   | ---       | $\Omega$  |
| $Q_g$        | Total Gate Charge (-4.5V)                      | $V_{DS}=-15V, V_{GS}=-4.5V, I_D=-15A$               | ---  | 12.5 | ---       | nC        |
| $Q_{gs}$     | Gate-Source Charge                             |                                                     | ---  | 5.4  | ---       |           |
| $Q_{gd}$     | Gate-Drain Charge                              |                                                     | ---  | 5    | ---       |           |
| $T_{d(on)}$  | Turn-On Delay Time                             | $V_{DD}=-15V, V_{GS}=-10V, R_G=3.3\Omega, I_D=-15A$ | ---  | 4.4  | ---       | ns        |
| $T_r$        | Rise Time                                      |                                                     | ---  | 11.2 | ---       |           |
| $T_{d(off)}$ | Turn-Off Delay Time                            |                                                     | ---  | 34   | ---       |           |
| $T_f$        | Fall Time                                      |                                                     | ---  | 18   | ---       |           |
| $C_{iss}$    | Input Capacitance                              | $V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$             | ---  | 1345 | ---       | pF        |
| $C_{oss}$    | Output Capacitance                             |                                                     | ---  | 194  | ---       |           |
| $C_{rss}$    | Reverse Transfer Capacitance                   |                                                     | ---  | 158  | ---       |           |

**Diode Characteristics**

| Symbol   | Parameter                                | Conditions                                   | Min. | Typ. | Max. | Unit |
|----------|------------------------------------------|----------------------------------------------|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,5</sup> | $V_G=V_D=0V$ , Force Current                 | ---  | ---  | -35  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V, I_S=-1A, T_J=25^{\circ}\text{C}$ | ---  | ---  | -1.2 | V    |
| $t_{rr}$ | Reverse Recovery Time                    | $I_F=-15A, dI/dt=100A/\mu s$ ,               | ---  | 12.4 | ---  | nS   |
| $Q_{rr}$ | Reverse Recovery Charge                  | $T_J=25^{\circ}\text{C}$                     | ---  | 5    | ---  | nC   |

Note :

1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.

2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$

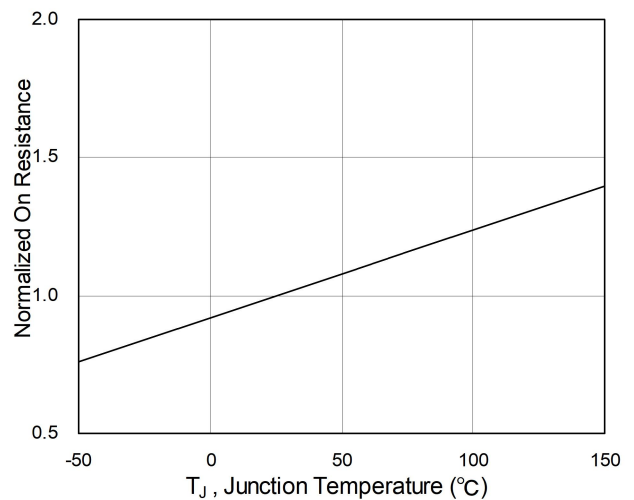
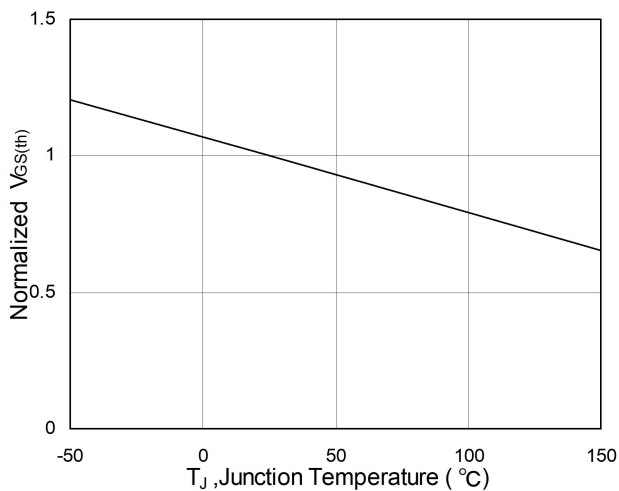
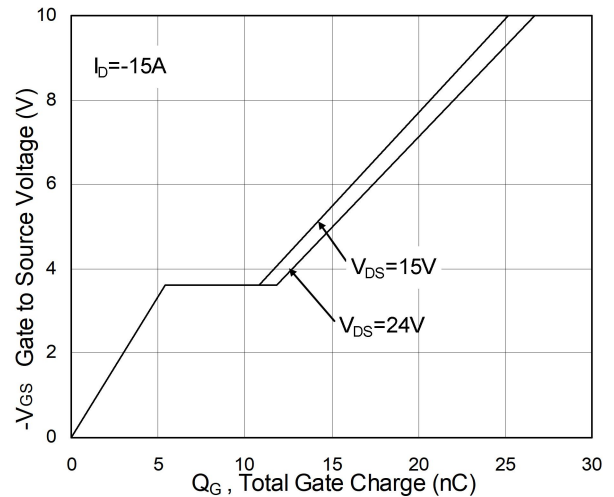
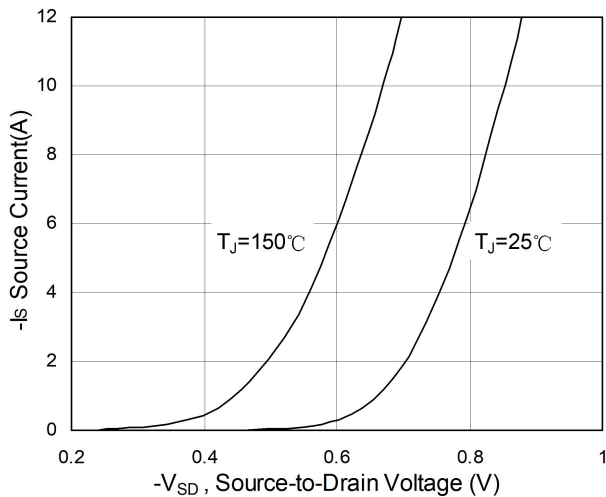
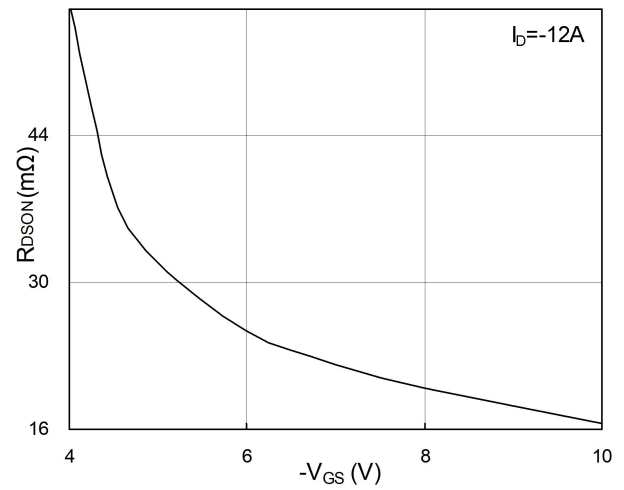
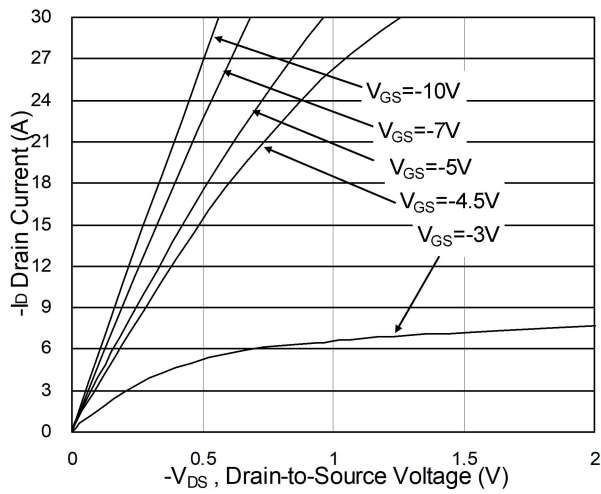
3.The EAS data shows Max. rating . The test condition is  $V_{DD}=-20V, V_{GS}=-10V, L=0.5mH, I_{AS}=-18A$

4.The power dissipation is limited by  $150^{\circ}\text{C}$  junction temperature

5.The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.

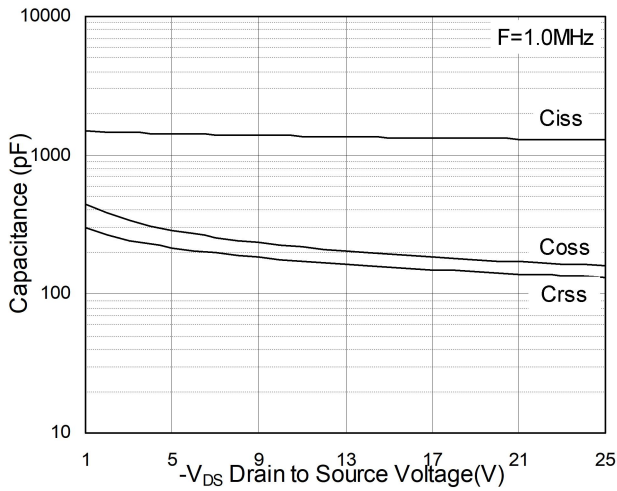
**P-Ch 30V Fast Switching MOSFETs**

**Typical Characteristics**

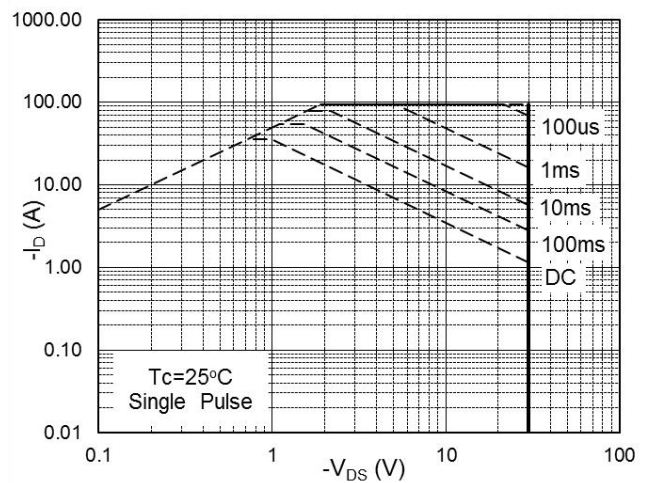




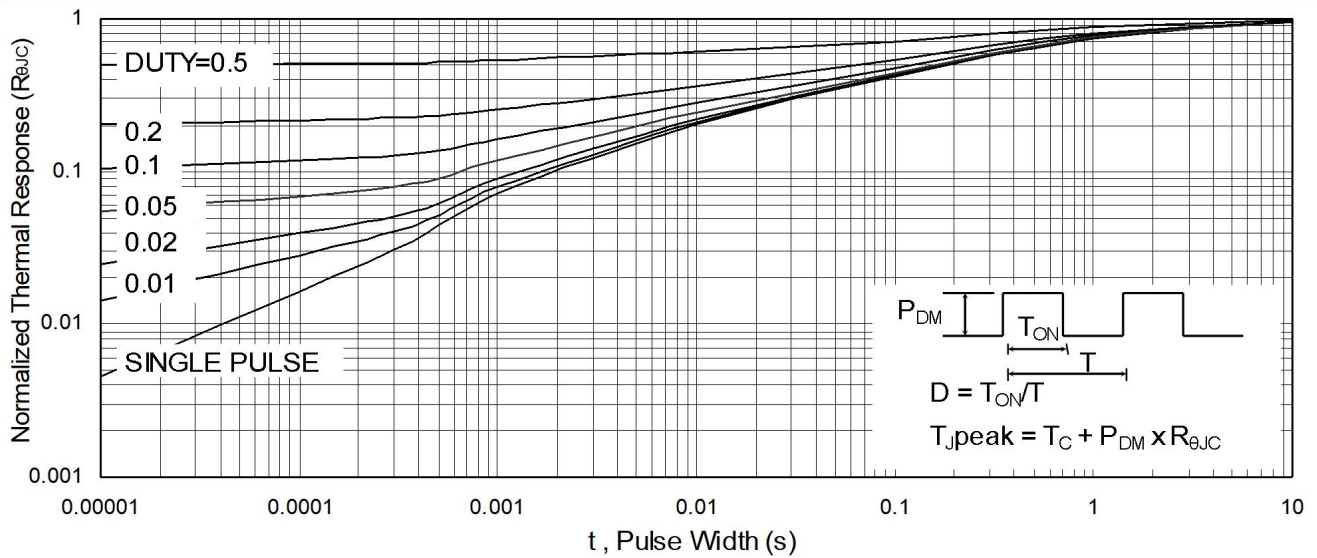
**P-Ch 30V Fast Switching MOSFETs**



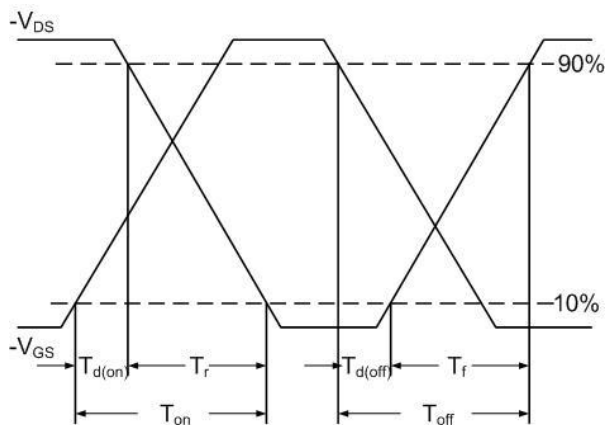
**Fig.7 Capacitance**



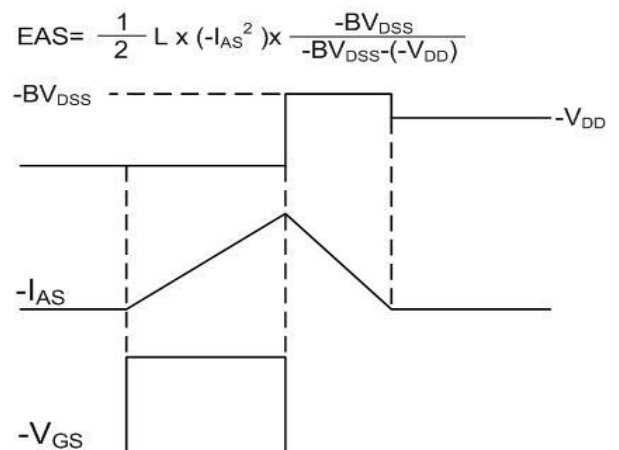
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



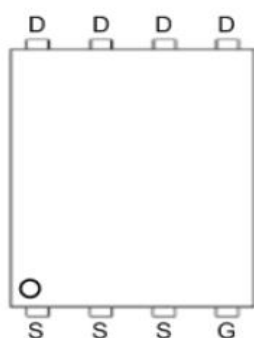
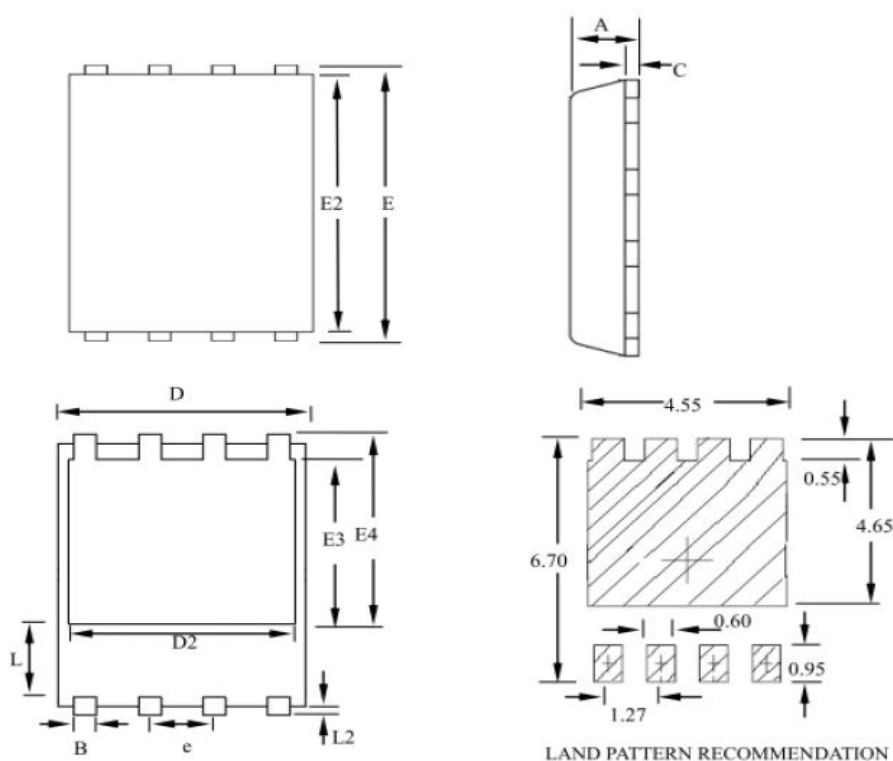
**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching Waveform**

## Ordering Information

| Part Number | Package code | Packaging      |
|-------------|--------------|----------------|
| HSBA3103    | PRPAK5*6     | 3000/Tape&Reel |



| SYMBOLS | MILLIMETERS |      |      | INCHES |       |       |
|---------|-------------|------|------|--------|-------|-------|
|         | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| A       | 0.80        | --   | 1.20 | 0.031  | --    | 0.047 |
| B       | 0.30        | --   | 0.51 | 0.012  | --    | 0.020 |
| C       | 0.15        | --   | 0.35 | 0.006  | --    | 0.014 |
| D       | 4.80        | --   | 5.30 | 0.189  | --    | 0.209 |
| D2      | 3.61        | --   | 4.35 | 0.142  | --    | 0.171 |
| E       | 5.90        | --   | 6.35 | 0.232  | --    | 0.250 |
| E2      | 5.42        | --   | 5.90 | 0.213  | --    | 0.232 |
| E3      | 3.23        | --   | 3.90 | 0.127  | --    | 0.154 |
| E4      | 3.69        | --   | 4.55 | 0.145  | --    | 0.179 |
| L       | 0.61        | --   | 1.80 | 0.024  | --    | 0.071 |
| L2      | 0.05        | --   | 0.36 | 0.002  | --    | 0.014 |
| e       | --          | 1.27 | --   | --     | 0.050 | --    |